

Anisotropic Conductive Paste for RFID

Features of SMERF®



* **BRIGHT[®]** Electro-conductive powders

BRIGHT[®] products are a series of hybrid electroconductive powders which are produced by coating highquality metals on its cores. The technology, an advanced electroless nickel / gold plating process has been invented and developed by Nippon Chemical Industrial Co., Ltd. The unique BRIGHT[®] electro-conductive powders are made by coating single or double layers of metal, (or metals) onto a variety of substrates such as high performance resin particles, metal particles, etc. The materials can be customized to meet the requirement of specific applications.



BRIGHT® Electro-conductive powders 3 µm Resin core Gold – Nickel coatings Spiky type



USP 6,770,369

Typical SMERF[®] properties

| SMERF ® | | RL0404 (Standard) | RL0407 (Standard) | RL0504 (High reliability) | RL0507 (High reliability) |
|---|-----------------------------|----------------------|----------------------|------------------------------|------------------------------|
| Application | | Dispensing, Jetting | | | |
| Electro-conductive particles Various types of powders can be selected from our standard and customized grades. | Core | Benzoguanamine | Benzoguanamine | Trade secret | Trade secret |
| | Coating(s) | Nickel / Gold | Nickel / Gold | Nickel / Gold | Nickel / Gold |
| | Particle size | 3 µm | 3 µm | 3 µm | 3 µm |
| Viscosity (Rheometer) | 1[1/s] | 25 Pa·s | 40 Pa•s | 25 Pa·s | 40 Pa•s |
| Thixotropic Index (Rheometer) | 1[1/s] / 10[1/s] | 2.7 | 2.2 | 2.7 | 2.2 |
| Gel time | 150 °C | 20 sec. | 20 sec. | 20 sec. | 20 sec. |
| Tg(DSC) | | 114 °C | 125 °C | 114 °C | 125 °C |
| Young's modulus | | 2850 MPa | 2990 MPa | 2850 MPa | 2990 MPa |
| Density | | 1.2 g/m ³ | 1.2 g/m ³ | 1.2 g/m ³ | 1.2 g/m ³ |
| Water adsorption | Boiling water for 2 hrs. | 0.4 % | 0.4 % | 0.4 % | 0.4 % |
| Pot Life | at 25 °C | 10 days | 10 days | 10 days | 10 days |
| | at 0 °C | 6 months | 6 months | 6 months | 6 months |
| Bonding Condition | 180 °C /180 °C | 6-7 sec. | 6-7 sec. | 6-7 sec. | 6-7 sec. |
| Please determine bonding conditions | 170 °C /170 °C | 7-8 sec. | 7-8 sec. | 7-8 sec. | 7-8 sec. |
| by preliminary testing | 160 ℃ /160 ℃ | 10 sec. | 10 sec. | 10 sec. | 10 sec. |

Performance of SMERF[®]

Appearance of Fillet

IC : I-CODE SLI Antenna : Aluminum ACP : RL0407 (Gold coated resin particle) Bonding Condition : 170 °C/170 °C, 2.5N, 10sec.



Cross Section of Electro – Conductive Particle



> The high reliability in various type of tags, such as for HF or for UHF

- The good adhesion and the high reliability in various materials of antenna, Copper, Aluminum and Silver Paste
- The little variation of the Q value after the reliability test (PCT 121 °C/ 100%RH / 2atm /10 hours, THT 85 °C/ 85%RH / 168 hours, TCT 85 °C ~ -40 °C / 500 cycles) in the HF antenna

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